



P95/P25

Isola offers a product line of polyimide-based prepreg (P25) and core material (P95) for high temperature printed circuit applications.

These products consist of an HB flammability rated polyimide resin system suitable for military, commercial or industrial electronic applications requiring superior performance and the utmost in thermal properties. These products utilize a polyimide and thermoplastic blend resin, fully cured without the use of MDA (Methylenedianiline). This results in a polymer with a high Tg without the characteristic difficulties of brittleness and low initial bond strength associated with traditional thermoset polyimides.

ORDERING INFORMATION:

Contact your local sales representative or visit www.isola-group.com for further information.

Isola Group
3100 West Ray Road
Suite 301
Chandler, AZ 85226
Phone: 480-893-6527
Fax: 480-893-1409
info@isola-group.com

Isola Asia Pacific (Hong Kong) Ltd.
Unit 3512 - 3522, 35/F
No. 1 Hung To Road, Kwun Tong,
Kowloon, Hong Kong
Phone: 852-2418-1318
Fax: 852-2418-1533
info.hkg@isola-group.com

Isola GmbH
Isola Strasse 2
D-52348 Düren, Germany
Phone: 49-2421-8080
Fax: 49-2421-808164
info-dur@isola-group.com

Performance

Tg 260°C

Td 416°C

Dk 3.76

Df 0.017

zIPC- 4101C /21 /24 /26 /98 /101 /126

UL - File Number E41625

Qualified to UL's MCIL Program

Product Features

- Industry Recognition
 - UL File Number: E41625
 - RoHS Compliant
- Performance Attributes
 - Halogen free
- Processing Advantages

Product Availability

- Standard Material Offering: Laminate
 - 2 to 125 mil (0.05 to 3.2 mm)
 - Available in full size sheet or panel form
- Copper Foil Type
 - HTE Grade 3
 - RTF (Reverse Treat Foil)
- Copper Weight
 - ½ to 2 oz (18 to 70 µm) available
 - Heavier copper available
 - Thinner copper foil available
- Standard Material Offering: Prepreg
 - Roll or panel form
 - Tooling of prepreg panels
- Glass Fabric Availability
 - E-glass

P95/P25 Specifications

Property		Typical Value	Units	Test Method
			Metric (English)	IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		260	°C	2.4.25
Decomposition Temperature (Td) by TGA @ 5% weight loss		416	°C	2.4.24.2
Time to Delaminate by TMA (Copper removed)	A. T260 B. T288	60	Minutes	2.4.24.1
Z-Axis CTE	A. Pre-Tg B. 50 to 260°C, (Total Expansion)	55 1.5	ppm/°C %	2.4.24
X/Y-Axis CTE	Pre-Tg	13/14	ppm/°C	2.4.24.1
Thermal Conductivity		0.4	W/mK	ASTM E1952
Thermal Stress 10 sec @ 288°C (550.4°F)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	A. @ 100 MHz B. @ 500 MHz C. @ 1 GHz D. @ 2 GHz E. @ 5 GHz F. @ 10 GHz	3.83 3.80 3.78 3.76 3.73 3.73	—	2.5.5.9 2.5.5.9 2.5.5.9 Bereskin Stripline Bereskin Stripline Bereskin Stripline
Df, Loss Tangent	A. @ 100 MHz B. @ 500 MHz C. @ 1 GHz D. @ 2 GHz E. @ 5 GHz F. @ 10 GHz	0.0135 0.0151 0.0172 0.0179 0.0188 0.021	—	2.5.5.9 2.5.5.9 2.5.5.9 Bereskin Stripline Bereskin Stripline Bereskin Stripline
Volume Resistivity	A. After moisture resistance B. At elevated temperature	3.0 x 10 ⁸ 7.0 x 10 ⁸	MΩ-cm	2.5.17.1
Surface Resistivity	A. After moisture resistance B. At elevated temperature	3.0 x 10 ⁶ 2.0 x 10 ⁸	MΩ	2.5.17.1
Dielectric Breakdown		>55	kV	2.5.6
Arc Resistance		130	Seconds	2.5.1
Electric Strength (Laminate & laminated prepreg)		44 (1100)	kV/mm (V/mil)	2.5.6.2
Comparative Tracking Index (CTI)		2 (250-399)	Class (Volts)	UL 746A ASTM D3638
Peel Strength	A. Low profile copper foil and very low profile copper foil all copper foil >17 μm [0.669 mil] B. Standard profile copper 1. After thermal stress 2. At 125°C (257°F) 3. After process solutions	1.14 (6.5) 1.25 (7.0) 1.25 (7.0) 1.14 (6.5)	N/mm (lb/inch)	2.4.8 2.4.8.2 2.4.8.3 2.4.8.3
Flexural Strength	A. Length direction B. Cross direction	58,700 66,200	lb/inch ²	2.4.4
Tensile Strength	A. Length direction B. Cross direction	54,540 36,111	lb/inch ²	ASTM D3039
Poisson's Ratio	A. Length direction B. Cross direction	0.187 0.164	—	ASTM D3039
Moisture Absorption		0.5	%	2.6.2.1
Flammability (Laminate & laminated prepreg)		HB	Rating	UL 94
Max Operating Temperature		130	°C	UL 796

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.

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